AN78Mxx/AN78MxxF Series

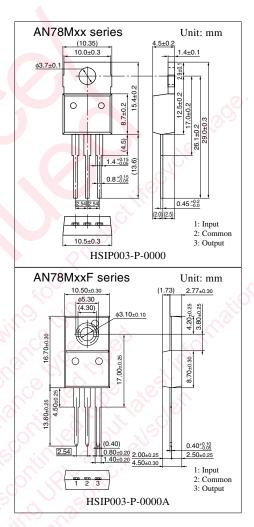
3-pin positive output voltage regulator (500 mA type)

Overview

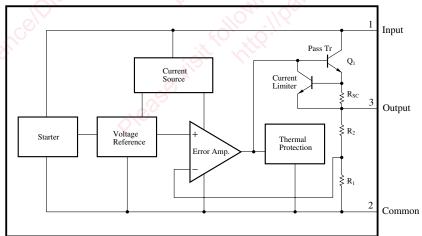
The AN78Mxx series and the AN78MxxF series are 3-pin fixed positive output type monolithic voltage regulators. Stabilized fixed output voltage is obtained from unstable DC input voltage without using any external components. 11 types of fixed output voltage are available; 5V, 6V, 7V, 8V, 9V, 10V, 12V, 15V, 18V, 20V and 24V. They can be used widely in power circuits with current capacity up to 500mA.

■ Features

- No external components
- Output voltage: 5V,6V,7V,8V,9V,10V,12V,15V,18V, 20V,24V
- Built-in overcurrent limit circuit
- Built-in thermal overload protection circuit
- Built-in ASO (area of safe operation) protection circuit



■ Block Diagram



■ Absolute Maximum Ratings at T_a = 25°C

Parameter		Symbol	Rating	Unit
Input voltage		V	35 *1	V
		V_{I}	40 *2	V
D dii	AN78xx series	D	15 *3	W
Power dissipation	AN78xxF series	P_{D}	10.25 *3	W
Operating ambient	temperature	$T_{ m opr}$	-20 to +80	°C
Storage temperature		T_{stg}	-55 to +150	°C

^{*1} AN78M05/F, AN78M06/F, AN78M07/F, AN78M08/F, AN78M09/F, AN78M10/F, AN78M12/F, AN78M15/F, AN78M18/F

■ Electrical Characteristics at T_a = 25°C

• AN78M05, AN78M05F (5V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	4.8	5	5.2	V
Output voltage tolerance	Vo	$V_{\rm I} = 7.5 \text{ to } 20\text{V}, I_{\rm O} = 5 \text{ to } 350\text{mA}, \\ T_{\rm j} = 25^{\circ}\text{C}, P_{\rm D} \le *$	4.75		5.25	V
Line regulation	REG _{IN}	$V_I = 7.5 \text{ to } 25V, T_j = 25^{\circ}C$		3	100	mV
Line regulation	KLOIN	$V_I = 8 \text{ to } 25V, T_j = 25^{\circ}C$		1	50	mV
Load regulation	REG _I	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		20	100	mV
Load regulation	KEUL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	50	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 8 \text{ to } 25V, T_j = 25^{\circ}C$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		40		μV
Ripple rejection ratio	RR	$V_I = 8 \text{ to } 18V, I_O = 100\text{mA}, f = 120\text{Hz}$	62			dB
Minimum input/output voltage difference	$V_{\text{DIF}(\text{min})}$	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2	_	V
Output short-circuit current	I _{O(Short)}	$V_I = 35V, T_j = 25^{\circ}C$		300	_	mA
Peak output current	I _{O(Peak)}	$T_j = 25^{\circ}C$	_	700	_	mA
Output voltage temperature coefficient	$\Delta V_{O}/T_{a}$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$		- 0.5	_	mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Panasonic

2

^{*2} AN78M20/F, AN78M24/F

^{*3} Follow the derating curve. When $T_{\rm j}$ exceeds 150°C, the internal circuit cuts off the output.

Note 2) Unless otherwise specified, $V_1 = 10V$, $I_0 = 350mA$, $C_1 = 0.33\mu F$ and $C_0 = 0.1\mu F$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

• AN78M06, AN78M06F (6V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	5.75	6	6.25	V
Output voltage tolerance	$V_{\rm O}$	$V_I = 8.5 \text{ to } 21V, I_O = 5 \text{ to } 350\text{mA}, T_j = 25^{\circ}\text{C}, P_D \le *$	5.7		6.3	V
Line regulation	REG_{IN}	$V_I = 8.5 \text{ to } 25V, T_j = 25^{\circ}C$		5	100	mV
Line regulation	KLOIN	$V_I = 9 \text{ to } 25V, T_j = 25^{\circ}C$		1.5	50	mV
Load regulation	REG_L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		20	120	mV
Load regulation	KEOL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	60	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 9 \text{ to } 25V, T_j = 25^{\circ}C$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		45		μV
Ripple rejection ratio	RR	$V_I = 9 \text{ to } 19V, I_O = 100\text{mA}, f = 120\text{Hz}$	59			dB
Minimum input/output voltage difference	$V_{\text{DIF}(\text{min})}$	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$	_	2	_	V
Output short-circuit current	I _{O(Short)}	$V_I = 35V, T_j = 25^{\circ}C$	_	300	_	mA
Peak output current	I _{O(Peak)}	$T_j = 25^{\circ}C$		700		mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$	_	- 0.5		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}$ C means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

• AN78M07, AN78M07F (7V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	6.7	7	7.3	V
Output voltage tolerance	Vo	$V_I = 9.5 \text{ to } 22V, I_O = 5 \text{ to } 350\text{mA}, \\ T_j = 25^{\circ}\text{C}, P_D \le *$	6.65		7.35	V
Line regulation	REG _{IN}	$V_I = 9.5 \text{ to } 25V, T_j = 25^{\circ}C$	—	6	100	mV
Line regulation	KEOIN	$V_I = 10 \text{ to } 25V, T_j = 25^{\circ}C$	—	2	50	mV
Load regulation	REG _L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		20	140	mV
Load regulation	KEUL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	70	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 10 \text{ to } 25\text{V}, T_j = 25^{\circ}\text{C}$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		48		μV
Ripple rejection ratio	RR	$V_I = 10$ to 20V, $I_O = 100$ mA, $f = 120$ Hz	57			dB
Minimum input/output voltage difference	$V_{\text{DIF}(min)}$	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2		V
Output short-circuit current	I _{O(Short)}	$V_I = 35V, T_j = 25^{\circ}C$		300		mA
Peak output current	I _{O(Peak)}	$T_j = 25^{\circ}C$		700		mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$	_	- 0.5	_	mV/°C

Note 1) The specified condition $T_j = 25^{\circ}$ C means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = 11V$, $I_O = 350 \text{mA}$, $C_I = 0.33 \mu\text{F}$ and $C_O = 0.1 \mu\text{F}$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

Note 2) Unless otherwise specified, $V_I = 12V$, $I_O = 350 \text{mA}$, $C_I = 0.33 \mu\text{F}$ and $C_O = 0.1 \mu\text{F}$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

• AN78M08, AN78M08F (8V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	7.7	8	8.3	V
Output voltage tolerance	Vo	$V_I = 10.5 \text{ to } 23\text{V}, I_O = 5 \text{ to } 350\text{mA}, \\ T_j = 25^{\circ}\text{C}, P_D \le *$	7.6	_	8.4	V
Line regulation	REG _{IN}	$V_I = 10.5 \text{ to } 25\text{V}, T_j = 25^{\circ}\text{C}$		6	100	mV
Line regulation	KEGIN	$V_I = 11 \text{ to } 25\text{V}, T_j = 25^{\circ}\text{C}$		2	50	mV
Load regulation	REG _L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		25	160	mV
Load regulation	KEUL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	80	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4.1	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 10.5 \text{ to } 25\text{V}, T_j = 25^{\circ}\text{C}$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		52		μV
Ripple rejection ratio	RR	$V_I = 11.5$ to 21.5V, $I_O = 100$ mA, $f = 120$ Hz	56			dB
Minimum input/output voltage difference	$V_{\text{DIF}(\text{min})}$	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$	_	2	_	V
Output short-circuit current	I _{O(Short)}	$V_I = 35V, T_j = 25^{\circ}C$		300		mA
Peak output current	$I_{O(Peak)}$	$T_j = 25^{\circ}C$		700		mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$		- 0.5		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}$ C means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

• AN78M09, AN78M09F (9V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	8.65	9	9.35	V
Output voltage tolerance	$V_{\rm o}$	$V_I = 11.5 \text{ to } 24V, I_O = 5 \text{ to } 350\text{mA},$ $T_j = 25^{\circ}\text{C}, P_D \le *$	8.55	_	9.45	V
Line regulation	REGIN	$V_I = 11.5 \text{ to } 25\text{V}, T_j = 25^{\circ}\text{C}$		7	100	mV
Eme regulation	KEGIN	$V_I = 12 \text{ to } 25V, T_j = 25^{\circ}C$		2	50	mV
Load regulation	REG_L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		25	180	mV
Load regulation	KEUL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	90	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4.1	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 12 \text{ to } 25V, T_j = 25^{\circ}C$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$		_	0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		60		μV
Ripple rejection ratio	RR	$V_I = 12 \text{ to } 22V, I_O = 100\text{mA}, f = 120\text{Hz}$	56			dB
Minimum input/output voltage difference	V _{DIF(min)}	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2		V
Output short-circuit current	$I_{O(Short)}$	$V_I = 35V, T_j = 25^{\circ}C$		300	_	mA
Peak output current	I _{O(Peak)}	$T_j = 25^{\circ}C$		700		mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$		- 0.5		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_1 = 14V$, $I_0 = 350\text{mA}$, $C_1 = 0.33\mu\text{F}$ and $C_0 = 0.1\mu\text{F}$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

Note 2) Unless otherwise specified, $V_I = 15V$, $I_O = 350 \text{mA}$, $C_I = 0.33 \mu\text{F}$ and $C_O = 0.1 \mu\text{F}$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

• AN78M10, AN78M10F (10V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	9.6	10	10.4	V
Output voltage tolerance	Vo	$V_I = 12.5 \text{ to } 25\text{V}, I_O = 5 \text{ to } 350\text{mA},$ $T_j = 25^{\circ}\text{C}, P_D \leq *$	9.5		10.5	V
Line regulation	REG _{IN}	$V_I = 12.5 \text{ to } 30V, T_j = 25^{\circ}C$	—	7	100	mV
	KEGIN	$V_I = 13 \text{ to } 25\text{V}, T_j = 25^{\circ}\text{C}$	—	2	50	mV
Load regulation	REG_L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$	—	25	200	mV
Load regulation	KEOL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	100	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4.1	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 13 \text{ to } 25\text{V}, T_j = 25^{\circ}\text{C}$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		65		μV
Ripple rejection ratio	RR	$V_I = 13 \text{ to } 23\text{V}, I_O = 100\text{mA}, f = 120\text{Hz}$	56			dB
Minimum input/output voltage difference	$V_{\text{DIF}(\text{min})}$	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2		V
Output short-circuit current	$I_{O(Short)}$	$V_I = 35V, T_j = 25^{\circ}C$		300		mA
Peak output current	$I_{O(Peak)}$	$T_j = 25^{\circ}C$		700	_	mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$		- 0.5		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}$ C means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

• AN78M12, AN78M12F (12V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	11.5	12	12.5	V
Output voltage tolerance	Vo	$V_{I} = 14.5 \text{ to } 27V, I_{O} = 5 \text{ to } 350\text{mA},$ $T_{j} = 25^{\circ}\text{C}, P_{D} \le *$	11.4	_	12.6	V
Line regulation	REG_{IN}	$V_I = 14.5 \text{ to } 30\text{V}, T_j = 25^{\circ}\text{C}$	—	8	100	mV
Ellic regulation	KEOIN	$V_I = 16 \text{ to } 30V, T_j = 25^{\circ}C$		2	50	mV
Load regulation	REG _L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		25	240	mV
Load regulation	KEUL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	120	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4.3	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 14.5 \text{ to } 30\text{V}, T_j = 25^{\circ}\text{C}$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$		_	0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		75		μV
Ripple rejection ratio	RR	$V_I = 15 \text{ to } 25V, I_O = 100\text{mA}, f = 120\text{Hz}$	55			dB
Minimum input/output voltage difference	$V_{\text{DIF}(\text{min})}$	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2	_	V
Output short-circuit current	I _{O(Short)}	$V_I = 35V, T_j = 25^{\circ}C$		300	_	mA
Peak output current	I _{O(Peak)}	$T_j = 25^{\circ}C$		700		mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$		- 0.8	_	mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = 16V$, $I_O = 350$ mA, $C_I = 0.33 \mu F$ and $C_O = 0.1 \mu F$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

Note 2) Unless otherwise specified, $V_I = 19V$, $I_O = 350 \text{mA}$, $C_I = 0.33 \mu\text{F}$ and $C_O = 0.1 \mu\text{F}$.

AN78Mxx series: 15W, AN78MxxF series: 10.25W

• AN78M15, AN78M15F (15V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	14.4	15	15.6	V
Output voltage tolerance	$V_{\rm o}$	$V_I = 17.5 \text{ to } 30V, I_O = 5 \text{ to } 350\text{mA},$ $T_j = 25^{\circ}\text{C}, P_D \leq *$	14.25		15.75	V
Line regulation	REGIN	$V_I = 17.5 \text{ to } 30V, T_j = 25^{\circ}C$		10	100	mV
Line regulation	KEUIN	$V_I = 20 \text{ to } 30V, T_j = 25^{\circ}C$		3	50	mV
Load regulation	DEC	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		25	300	mV
Load regulation	REG _L	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$	_	10	150	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4.3	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 17.5 \text{ to } 30V, T_j = 25^{\circ}C$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		90		μV
Ripple rejection ratio	RR	V _I = 18.5 to 28.5V, I _O = 100mA, f = 120Hz	54			dB
Minimum input/output voltage difference	V _{DIF(min)}	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2		V
Output short-circuit current	$I_{O(Short)}$	$V_I = 35V, T_j = 25^{\circ}C$		300	_	mA
Peak output current	I _{O(Peak)}	$T_j = 25^{\circ}C$	_	700	_	mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$	—	-1		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

• AN78M18, AN78M18F (18V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	17.3	18	18.7	V
Output voltage tolerance	Vo	$V_I = 21 \text{ to } 33V, I_O = 5 \text{ to } 350\text{mA},$ $T_j = 25^{\circ}\text{C}, P_D \leq *$	17.1		18.9	V
Line regulation	REG _{IN}	$V_I = 21 \text{ to } 33V, T_j = 25^{\circ}C$		10	100	mV
Line regulation	KEGIN	$V_I = 22 \text{ to } 33V, T_j = 25^{\circ}C$		5	50	mV
Load regulation	REG _L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		30	360	mV
Load regulation	KEOL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	180	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4.4	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 21 \text{ to } 33V, T_j = 25^{\circ}C$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to $100kHz$		100		μV
Ripple rejection ratio	RR	$V_I = 22 \text{ to } 32\text{V}, I_O = 100\text{mA}, f = 120\text{Hz}$	53		_	dB
Minimum input/output voltage difference	$V_{\text{DIF}(\text{min})}$	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2		V
Output short-circuit current	I _{O(Short)}	$V_I = 35V, T_j = 25^{\circ}C$		300		mA
Peak output current	I _{O(Peak)}	$T_j = 25^{\circ}C$		700	_	mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$		-1.0		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = 23V$, $I_O = 350mA$, $C_I = 0.33\mu F$ and $C_O = 0.1\mu F$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

Note 2) Unless otherwise specified, $V_1 = 27V$, $I_0 = 350\text{mA}$, $C_1 = 0.33\mu\text{F}$ and $C_0 = 0.1\mu\text{F}$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

• AN78M20, AN78M20F (20V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	19.2	20	20.8	V
Output voltage tolerance	Vo	$V_I = 23 \text{ to } 35\text{V}, I_O = 5 \text{ to } 350\text{mA},$ $T_j = 25^{\circ}\text{C}, P_D \le *$	19		21	V
Line regulation	REG _{IN}	$V_I = 23 \text{ to } 35\text{V}, T_j = 25^{\circ}\text{C}$		10	100	mV
	KEGIN	$V_I = 24 \text{ to } 35\text{V}, T_j = 25^{\circ}\text{C}$	—	5	50	mV
Load regulation	REG_L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$	—	30	400	mV
Load regulation	KEOL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	200	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4.4	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 23 \text{ to } 35\text{V}, T_j = 25^{\circ}\text{C}$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		110		μV
Ripple rejection ratio	RR	$V_I = 24 \text{ to } 34\text{V}, I_O = 100\text{mA}, f = 120\text{Hz}$	53	_		dB
Minimum input/output voltage difference	$V_{\text{DIF}(\text{min})}$	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2		V
Output short-circuit current	$I_{O(Short)}$	$V_I = 35V, T_j = 25^{\circ}C$		300		mA
Peak output current	$I_{O(Peak)}$	$T_j = 25^{\circ}C$		700		mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$		-1.0		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

• AN78M24, AN78M24F (24V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	V_{O}	$T_j = 25^{\circ}C$	23	24	25	V
Output voltage tolerance	$V_{\rm o}$	$V_I = 27 \text{ to } 38V, I_O = 5 \text{ to } 350\text{mA},$ $T_j = 25^{\circ}\text{C}, P_D \le *$	22.8	_	25.2	V
Line regulation	REG_{IN}	$V_I = 27 \text{ to } 38V, T_j = 25^{\circ}C$		10	100	mV
Eme regulation	KEGIN	$V_I = 28 \text{ to } 38V, T_j = 25^{\circ}C$		5	50	mV
Load regulation	REG_L	$I_0 = 5 \text{ to } 500\text{mA}, T_j = 25^{\circ}\text{C}$		30	480	mV
Load regulation	KEUL	$I_0 = 5 \text{ to } 200\text{mA}, T_j = 25^{\circ}\text{C}$		10	240	mV
Bias current	I_{Bias}	$T_j = 25^{\circ}C$		4.5	6	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = 27 \text{ to } 38V, T_j = 25^{\circ}C$			0.8	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 5 \text{ to } 350 \text{mA}, T_j = 25^{\circ}\text{C}$			0.5	mA
Output noise voltage	V_{no}	f = 10Hz to 100kHz		170		μV
Ripple rejection ratio	RR	$V_I = 28 \text{ to } 38V, I_O = 100\text{mA}, f = 120\text{Hz}$	50			dB
Minimum input/output voltage difference	V _{DIF(min)}	$I_0 = 500 \text{mA}, T_j = 25^{\circ}\text{C}$		2		V
Output short-circuit current	$I_{O(Short)}$	$V_I = 35V, T_j = 25^{\circ}C$		300	_	mA
Peak output current	I _{O(Peak)}	$T_j = 25^{\circ}C$		700		mA
Output voltage temperature coefficient	$\Delta V_O/T_a$	$I_0 = 5 \text{mA}, T_j = 0 \text{ to } 125^{\circ}\text{C}$		-1.2		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Panasonic

7

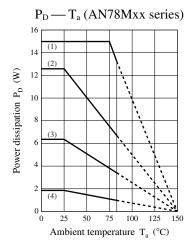
Note 2) Unless otherwise specified, $V_I = 29V$, $I_O = 350mA$, $C_I = 0.33\mu F$ and $C_O = 0.1\mu F$.

^{*} AN78Mxx series: 15W, AN78MxxF series: 10.25W

Note 2) Unless otherwise specified, $V_I = 33V$, $I_O = 350mA$, $C_I = 0.33\mu F$ and $C_O = 0.1\mu F$.

AN78Mxx series: 15W, AN78MxxF series: 10.25W

Main Characteristics



Thermal resistance value:

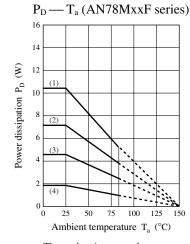
$$R_{th(j-c)} = 5$$
°C/W (max.)
 $R_{th(j-a)} = 65$ °C/W (max.)

Installation condition to heat sink Tightening torque 6kg·cm Heat radiation compound used

(1) Infinite heat sink: 15.0W (2) 5°C/W heat sink: 12.5W

(3) 15°C/W heat sink: 6.3W

(4) Without heat sink: 1.923W



Thermal resistance value:
$$R_{th(j-c)} = 12.2^{\circ}\text{C/W (max.)} \\ R_{th(j-a)} = 65^{\circ}\text{C/W (max.)}$$

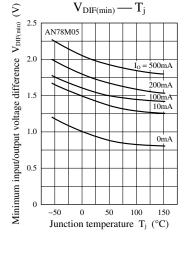
Installation condition to heat sink Tightening torque 6kg·cm Heat radiation compound used

(1) Infinite heat sink: 10.25W

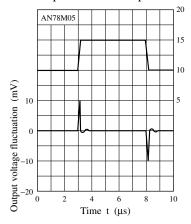
(2) 5°C/W heat sink: 7.3W

(3) 15°C/W heat sink: 4.5W

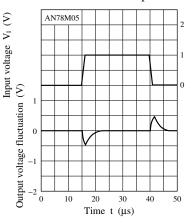
(4) Without heat sink: 1.923W



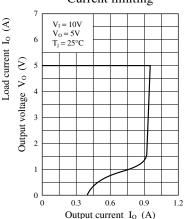
Input transient response



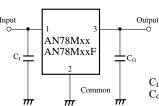
Load transient response



Current limiting



■ Basic Regulator Circuit



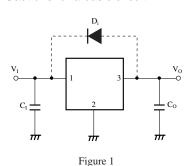
t

C_I is necessary when the input line is long.

C_O improves the transient response.

■ Usage Notes

1. Cautions for a basic circuit

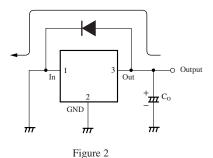


- C_I : When a wiring from a smoothing circuit to a three-pin regulator is long, it is likely to oscillate at output. A capacitor of $0.1\mu F$ to $0.47\mu F$ should be connected near an input pin.
- C_O : When any sudden change of load current is likely to occur, connect an electrolytic capacitor of $10\mu F$ to $100\mu F$ to improve a transitional response of output voltage.
- D_i: Normally unnecessary. But add it in the case that there is a residual voltage at the output capacitor Co even after switching off the supply power because a current is likely to flow into an output pin of the IC and damage the IC.

2. Other caution items

1) Short-circuit between the input pin and GND pin

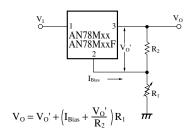
If the input pin is short-circuitted to GND or is cut off when a large capacitance capacitor has been connected to the IC's load, a voltage of a capacitor connected to an output pin is applied between input/output of the IC and this likely results in damage of the IC. It is necessary, therefore, to connect a diode, as shown in figure 2, to counter the reverse bias between input/output pins.

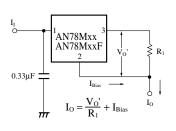


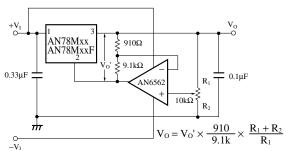
2) Floating of GND pin

If a GND pin is made floating in an operating mode, an unstabilized input voltage is outputted. In this case, a thermal protection circuit inside the IC does not normally operate. In this state, if the load is short-circuited or overloaded, it is likely to damage the IC.

■ Application Circuit Examples

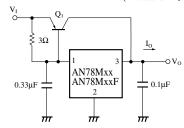






 $V_{\rm O}$ varies with the value of the input voltage $V_{\rm 1}$. (In case of $R_{\rm 1}+R_{\rm 2}=10k\Omega)$

9



Request for your special attention and precautions in using the technical information and semiconductors described in this book

- (1) If any of the products or technical information described in this book is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially, those with regard to security export control, must be observed.
- (2) The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products, and no license is granted under any intellectual property right or other right owned by our company or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information described in this book.
- (3) The products described in this book are intended to be used for standard applications or general electronic equipment (such as office equipment, communications equipment, measuring instruments and household appliances).

 Consult our sales staff in advance for information on the following applications:
 - Special applications (such as for airplanes, aerospace, automobiles, traffic control equipment, combustion equipment, life support
 systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
 - · Any applications other than the standard applications intended.
- (4) The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.
 - Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- (7) This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of Matsushita Electric Industrial Co., Ltd.